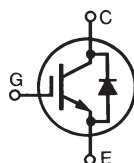


High Voltage, BiMOSFET™ Monolithic Bipolar MOS Transistor

IXBT42N300HV IXBH42N300HV



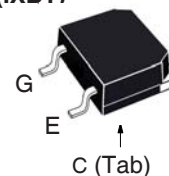
$$V_{CES} = 3000V$$

$$I_{C110} = 42A$$

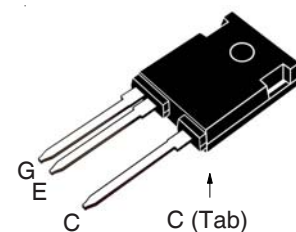
$$V_{CE(sat)} \leq 3.0V$$

| Symbol | Test Conditions | Maximum Ratings | |
|--|--|-----------------------|------------|
| V_{CES} | $T_C = 25^\circ C$ to $150^\circ C$ | 3000 | V |
| V_{CGR} | $T_J = 25^\circ C$ to $150^\circ C$, $R_{GE} = 1M\Omega$ | 3000 | V |
| V_{GES} | Continuous | ± 25 | V |
| V_{GEM} | Transient | ± 35 | V |
| I_{C25} | $T_C = 25^\circ C$ | 104 | A |
| I_{C110} | $T_C = 110^\circ C$ | 42 | A |
| I_{CM} | $T_C = 25^\circ C$, 1ms | 400 | A |
| SSOA (RBSOA) | $V_{GE} = 15V$, $T_{VJ} = 125^\circ C$, $R_G = 20\Omega$ Clamped Inductive Load | $I_{CM} = 84$ 1500 | A V |
| T_{SC} (SCSOA) | $V_{GE} = 15V$, $T_J = 125^\circ C$, $R_G = 82\Omega$, $V_{CE} = 1500V$, Non-Repetitive | 10 | μS |
| P_C | $T_C = 25^\circ C$ | 500 | W |
| T_J | | -55 ... +150 | $^\circ C$ |
| T_{JM} | | 150 | $^\circ C$ |
| T_{stg} | | -55 ... +150 | $^\circ C$ |
| T_L | 1.6mm (0.062 in.) from Case for 10s | 300 | $^\circ C$ |
| T_{SOLD} | Plastic Body for 10 seconds | 260 | $^\circ C$ |
| M_d | Mounting Torque (TO-247HV) | 1.13/10 | Nm/lb.in |
| Weight | TO-268HV | 4 | g |
| | TO-247HV | 6 | g |

TO-268HV (IXBT)



TO-247HV (IXBH)



G = Gate C = Collector
E = Emitter Tab = Collector

Features

- High Voltage Package
- High Blocking Voltage
- High Peak Current Capability
- Low Saturation Voltage
- FBSOA
- SCSOA

Advantages

- Low Gate Drive Requirement
- High Power Density

Applications

- Laser Generators
- Capacitor Discharge Circuits
- AC Switches
- Protection Circuits

| Symbol | Test Conditions ($T_J = 25^\circ C$ Unless Otherwise Specified) | Characteristic Values | | |
|---------------|---|-----------------------|------|--------------------------|
| | | Min. | Typ. | Max. |
| BV_{CES} | $I_C = 1mA$, $V_{GE} = 0V$ | 3000 | | V |
| $V_{GE(th)}$ | $I_C = 1mA$, $V_{CE} = V_{GE}$ | 3.0 | | 5.0 V |
| I_{CES} | $V_{CE} = 0.8 \cdot V_{CES}$, $V_{GE} = 0V$ $T_J = 125^\circ C$ | | 250 | 50 μA 50 μA |
| I_{GES} | $V_{CE} = 0V$, $V_{GE} = \pm 25V$ | | | ± 200 nA |
| $V_{CE(sat)}$ | $I_C = 42A$, $V_{GE} = 15V$, Note 1 $T_J = 125^\circ C$ | | 2.5 | 3.0 V |
| | | | 3.1 | V |

| Symbol Test Conditions ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified) | | Characteristic Values | | |
|--|--|-----------------------|------|-------------------------|
| | | Min. | Typ. | Max. |
| g_{fs} | $I_C = 42\text{A}, V_{CE} = 10\text{V}$, Note 1 | 28 | 45 | S |
| C_{ies} | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$ | | 4780 | pF |
| C_{oes} | | | 170 | pF |
| C_{res} | | | 56 | pF |
| R_{Gi} | Gate Input Resistance | | 3.0 | Ω |
| Q_g | $I_C = 42\text{A}, V_{GE} = 15\text{V}, V_{CE} = 1000\text{V}$ | | 200 | nC |
| Q_{ge} | | | 28 | nC |
| Q_{gc} | | | 75 | nC |
| $t_{d(on)}$ | Resistive Switching Times, $T_J = 25^\circ\text{C}$ $I_C = 42\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 1500\text{V}, R_G = 20\Omega$ | | 72 | ns |
| t_r | | | 330 | ns |
| $t_{d(off)}$ | | | 445 | ns |
| t_f | | | 610 | ns |
| $t_{d(on)}$ | Resistive Switching Times, $T_J = 125^\circ\text{C}$ $I_C = 42\text{A}, V_{GE} = 15\text{V}$ $V_{CE} = 1500\text{V}, R_G = 20\Omega$ | | 72 | ns |
| t_r | | | 580 | ns |
| $t_{d(off)}$ | | | 460 | ns |
| t_f | | | 490 | ns |
| R_{thJC} | | | | 0.25 $^\circ\text{C/W}$ |
| R_{thCS} | TO-247HV | | 0.21 | $^\circ\text{C/W}$ |

Reverse Diode

| Symbol Test Conditions ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified) | | Characteristic Values | | |
|--|--|---|------|---------------|
| | | Min. | Typ. | Max |
| V_F | $I_F = 42\text{A}, V_{GE} = 0\text{V}$, Note 1 | | | 2.5 V |
| t_{rr} | $I_F = 21\text{A}, V_{GE} = 0\text{V}, -di_F/dt = 100\text{A}/\mu\text{s}$ | | 1.7 | μs |
| I_{RM} | | $V_R = 100\text{V}, V_{GE} = 0\text{V}$ | | 43 |

Note 1. Pulse test, $t < 300\mu\text{s}$, duty cycle, $d < 2\%$.

PRELIMINARY TECHNICAL INFORMATION

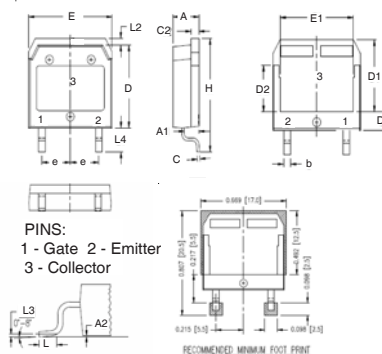
The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

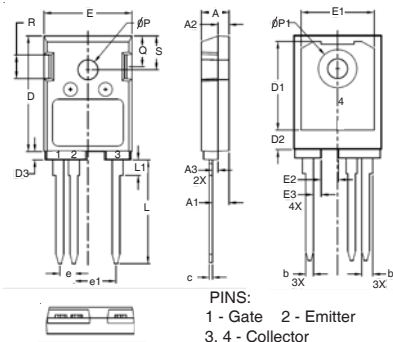
| | | | | | | | | | |
|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| 4,860,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 | |
| 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 | |

TO-268HV Outline



| SYM | INCHES | | MILLIMETER | |
|-----|--------|------|------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .193 | .201 | 4.90 | 5.10 |
| A1 | .106 | .114 | 2.70 | 2.90 |
| A2 | .001 | .010 | 0.02 | 0.25 |
| b | .045 | .057 | 1.15 | 1.45 |
| C | .016 | .026 | 0.40 | 0.65 |
| C2 | .057 | .063 | 1.45 | 1.60 |
| D | .543 | .551 | 13.80 | 14.00 |
| D1 | .465 | .476 | 11.80 | 12.10 |
| D2 | .295 | .307 | 7.50 | 7.80 |
| D3 | .114 | .126 | 2.90 | 3.20 |
| E | .624 | .632 | 15.85 | 16.05 |
| E1 | .524 | .535 | 13.30 | 13.60 |
| E | .215 | BSC | 5.45 | BSC |
| H | .736 | .752 | 18.70 | 19.10 |
| L | .067 | .079 | 1.70 | 2.00 |
| L2 | .039 | .045 | 1.00 | 1.15 |
| L3 | .010 | BSC | 0.25 | BSC |
| L4 | .150 | .161 | 3.80 | 4.10 |

TO-247HV Outline



| SYM | INCHES | | MILLIMETERS | |
|-----|--------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .193 | .201 | 4.90 | 5.10 |
| A1 | .114 | .122 | 2.90 | 3.10 |
| A2 | .075 | .083 | 1.90 | 2.10 |
| A3 | .035 | .043 | 0.90 | 1.10 |
| b | .053 | .059 | 1.35 | 1.50 |
| b1 | .075 | .083 | 1.90 | 2.10 |
| c | .022 | .030 | 0.55 | 0.75 |
| D | .819 | .843 | 20.80 | 21.40 |
| D1 | .638 | .646 | 16.20 | 16.40 |
| D2 | .134 | .146 | 3.40 | 3.70 |
| D3 | .055 | .063 | 1.40 | 1.60 |
| E | .622 | .638 | 15.80 | 16.20 |
| E1 | .520 | .528 | 13.20 | 13.40 |
| E2 | .118 | .126 | 3.00 | 3.20 |
| E3 | .051 | .059 | 1.30 | 1.50 |
| e | .100 | BSC | 2.54 | BSC |
| e1 | .300 | BSC | 7.62 | BSC |
| L | .732 | .748 | 18.60 | 19.00 |
| L1 | .106 | .118 | 2.70 | 3.00 |
| ØP | .138 | .142 | 3.50 | 3.60 |
| ØP1 | .272 | .280 | 6.90 | 7.10 |
| Q | .216 | .224 | 5.50 | 5.70 |
| R | .165 | .169 | 4.20 | 4.30 |
| S | .240 | .248 | 6.10 | 6.30 |

Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

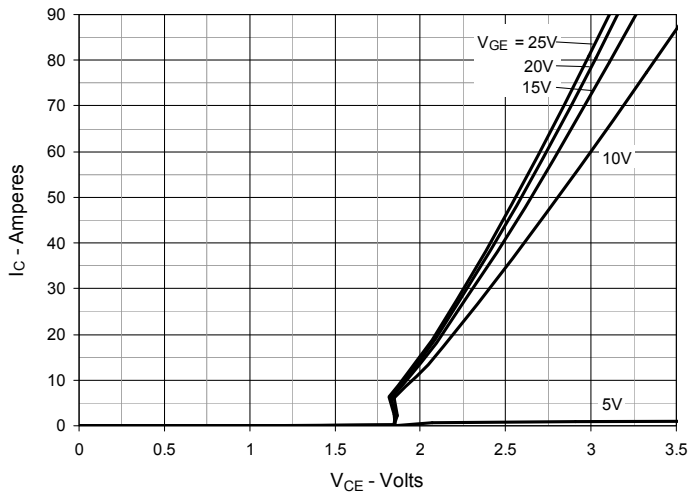


Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

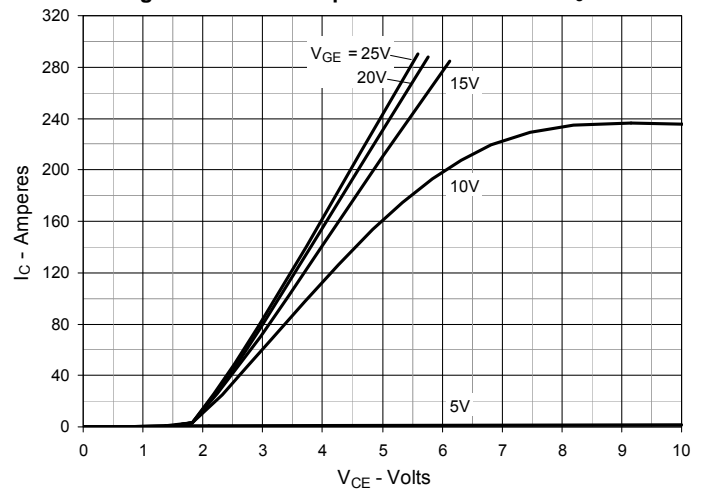


Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

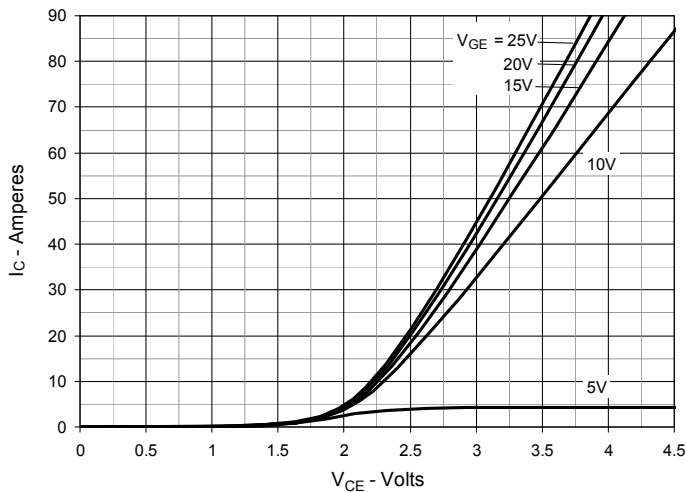


Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

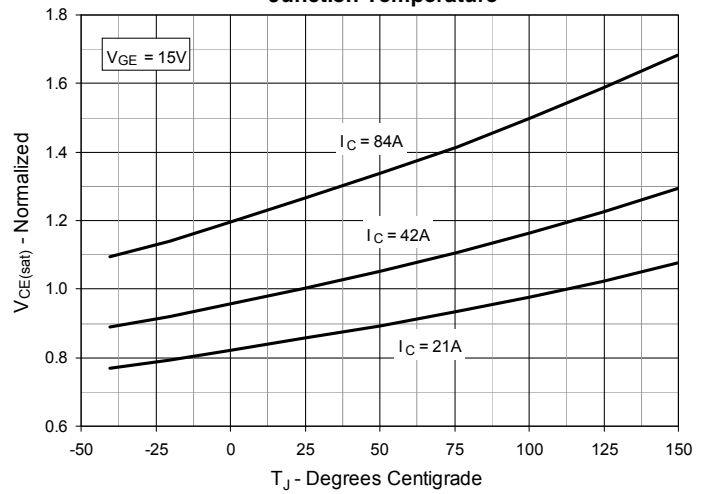


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

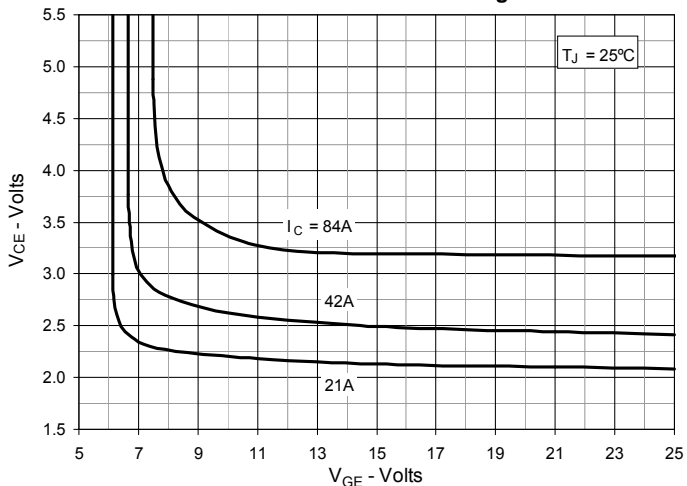


Fig. 6. Input Admittance

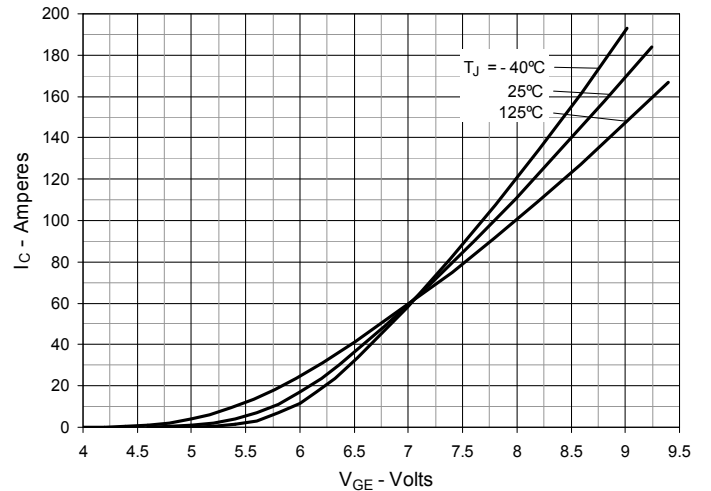


Fig. 7. Transconductance

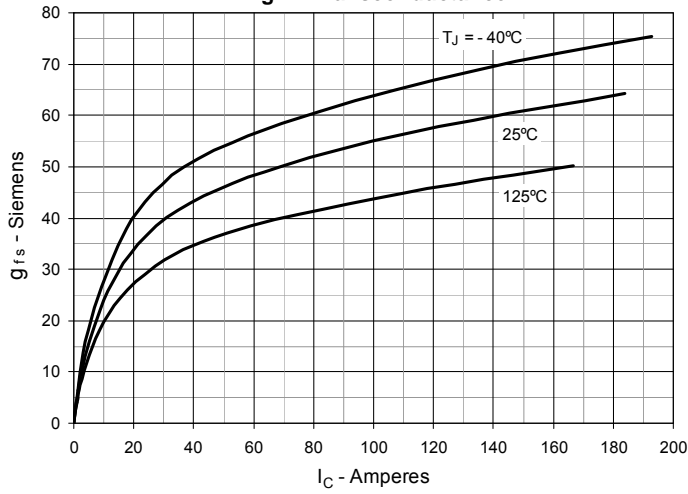


Fig. 8. Forward Voltage Drop of Intrinsic Diode

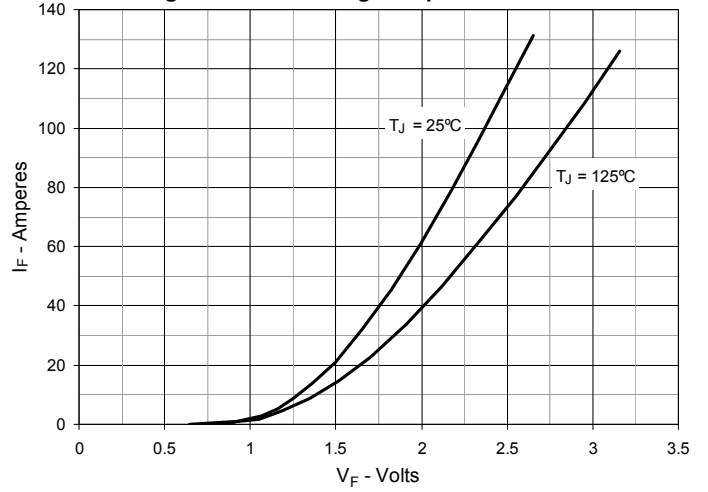


Fig. 9. Gate Charge

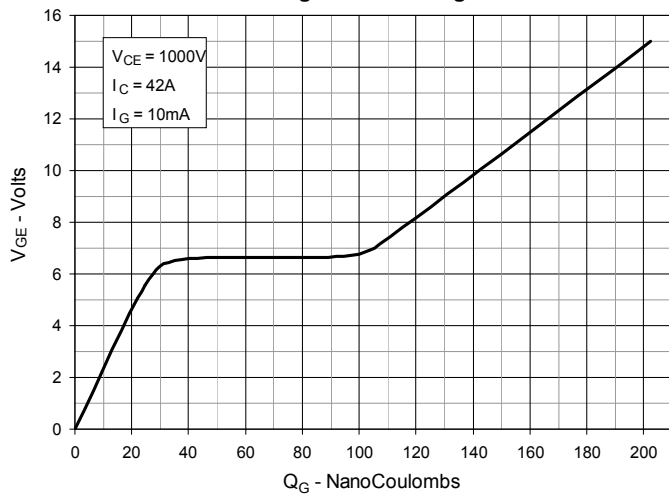


Fig. 10. Capacitance

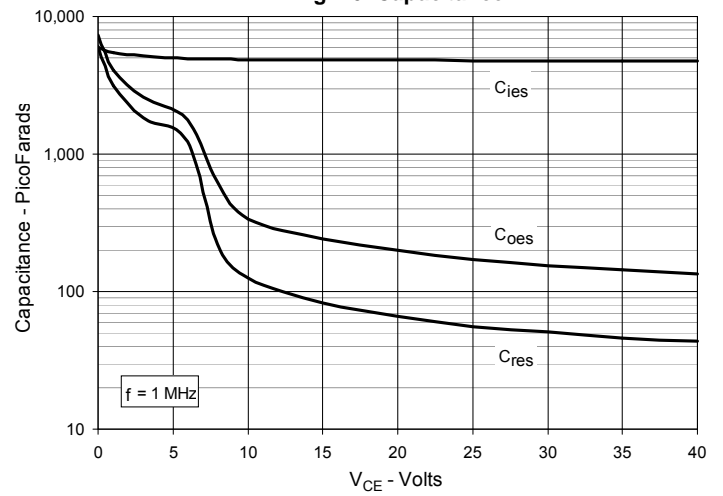


Fig. 11. Reverse-Bias Safe Operating Area

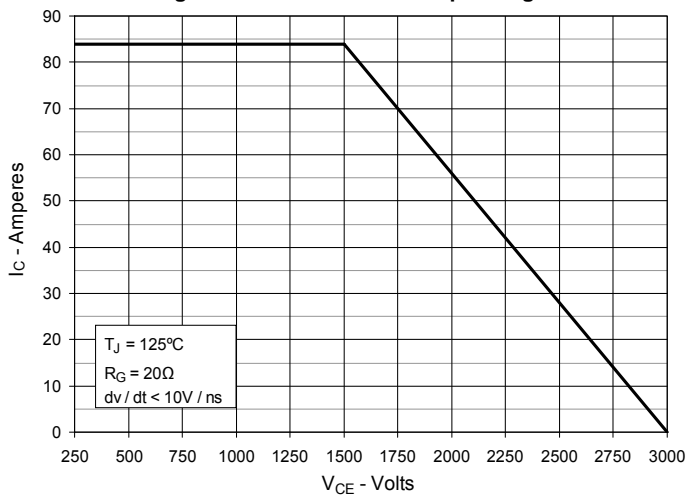


Fig. 12. Maximum Transient Thermal Impedance

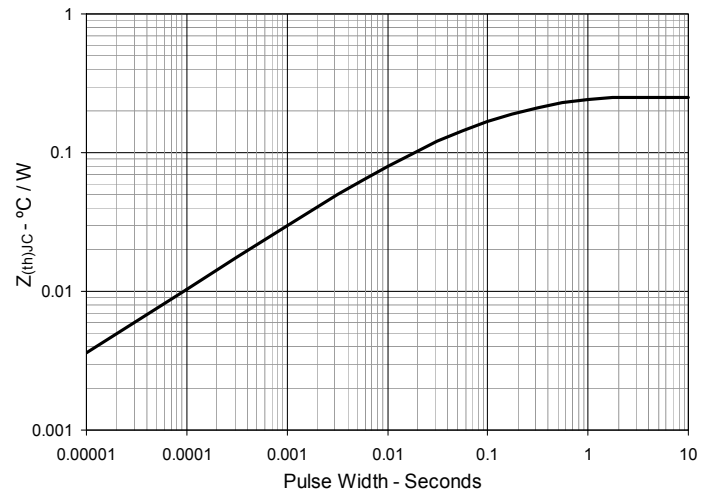


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

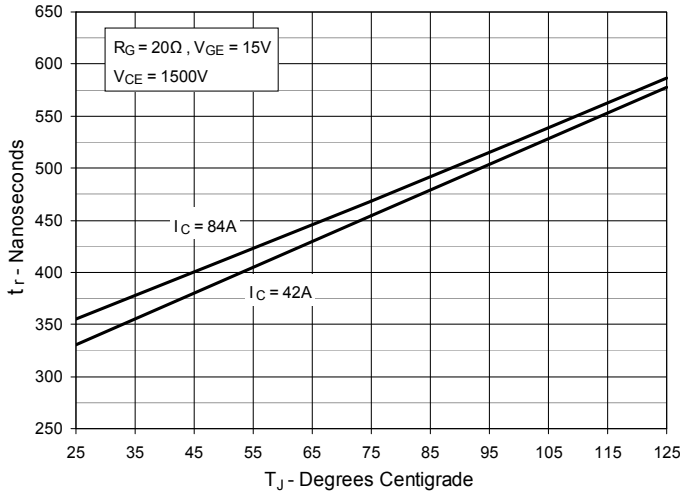


Fig. 14. Resistive Turn-on Rise Time vs. Collector Current

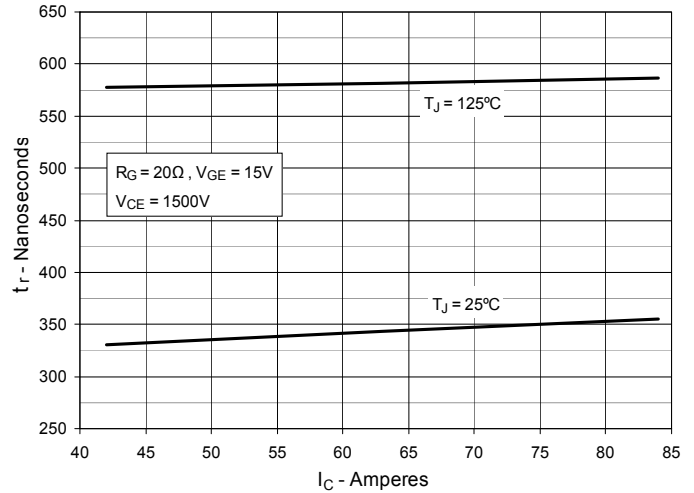


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

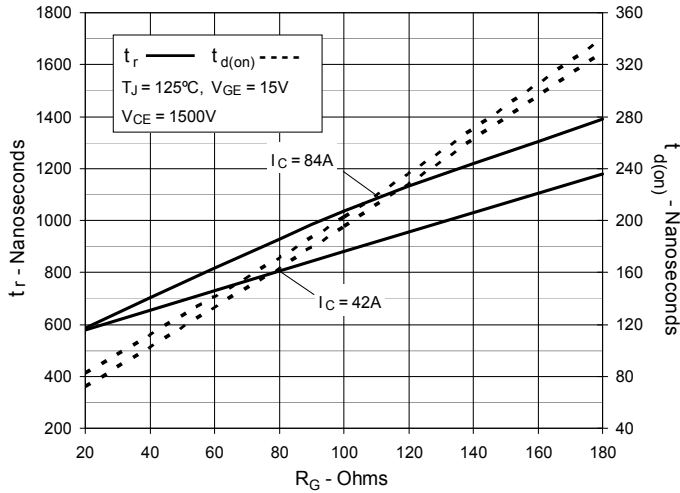


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

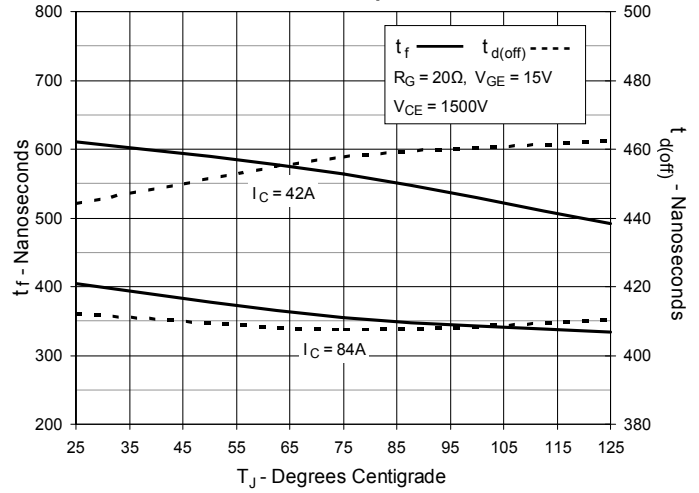


Fig. 17. Resistive Turn-off Switching Times vs. Collector Current

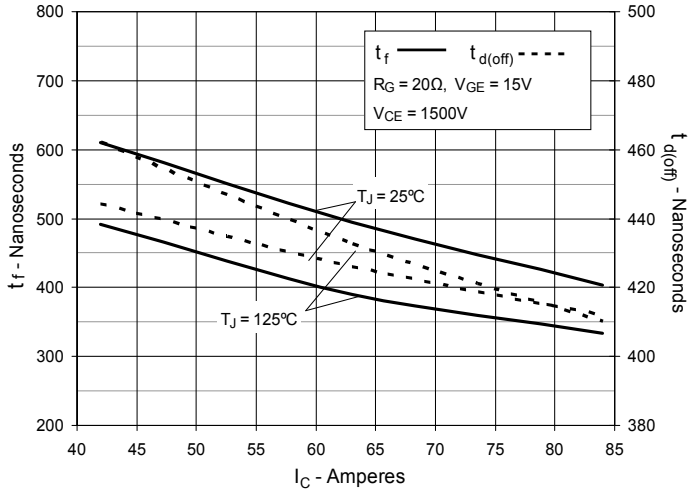


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance

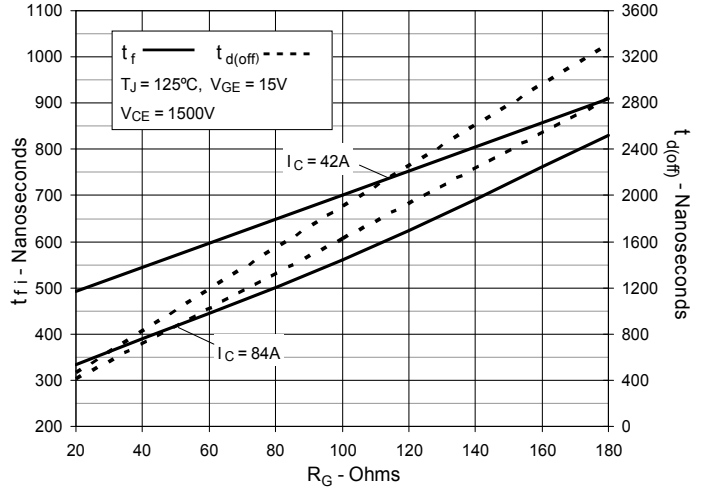


Fig. 19. Forward-Bias Safe Operating Area @ $T_C = 25^\circ\text{C}$

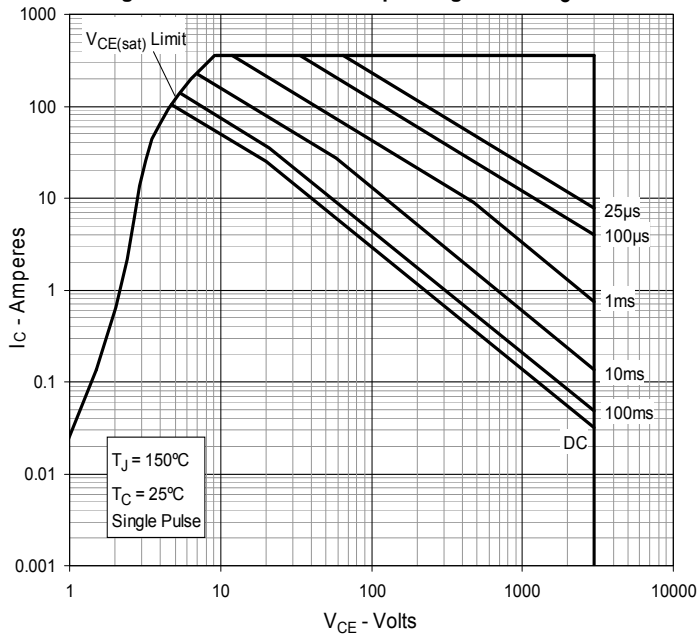
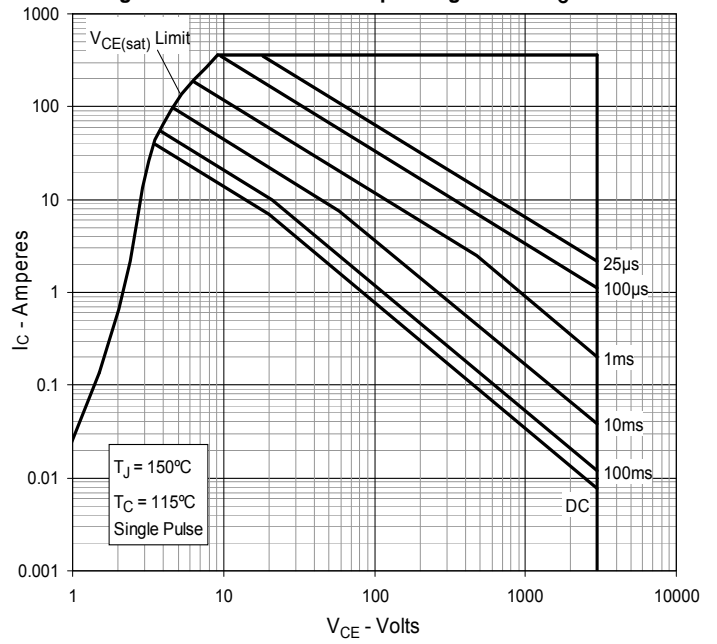


Fig. 20. Forward-Bias Safe Operating Area @ $T_C = 115^\circ\text{C}$



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[FGH60N60SMD_F085](#) [FGH75T65UPD](#) [STGWA15H120F2](#) [IKA10N60TXKSA1](#) [IHW20N120R5XKSA1](#) [RJH60D2DPP-M0#T2](#)
[IKP20N60TXKSA1](#) [IHW20N65R5XKSA1](#)